

## IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant : Tomofumi MAEKAWA Confirmation No.: 9960  
Serial No : 10/582,556 (National Stage of PCT/JP2004/018388) Group Art Unit: 1796  
I.A. Filed : December 9, 2004 Examiner: David Buttner  
For : THERMOPLASTIC RESIN HAVING RIGIDITY WHEN HEATED

**COMMENTS ON STATEMENT OF REASONS FOR ALLOWANCE**

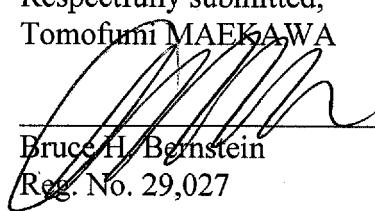
Commissioner of Patents  
U.S. Patent and Trademark Office  
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Randolph Building  
401 Dulany Street  
Alexandria, VA 22314

Sir:

In response to the Notice of Allowability, mailed by the U.S. Patent and Trademark Office on October 14, 2009, and to the Statement of Reasons for Allowance attached thereto, Applicants wish to clarify the record with respect to the basis for the patentability of claims in the present application. In this regard, while Applicants do not disagree with the Examiner's indication of allowability, Applicants submit that each of the claims in the present application recites a combination of features, and that the basis for patentability of each of these claims is based on the combination of features recited therein.

Should there be any questions, the Examiner is invited to contact the undersigned at the below- listed telephone number.

Respectfully submitted,  
Tomofumi MAEKAWA

  
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January 13, 2010  
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